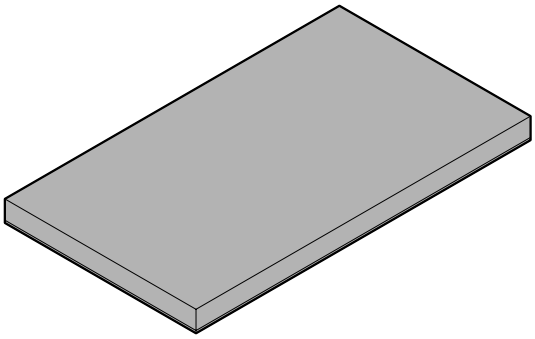
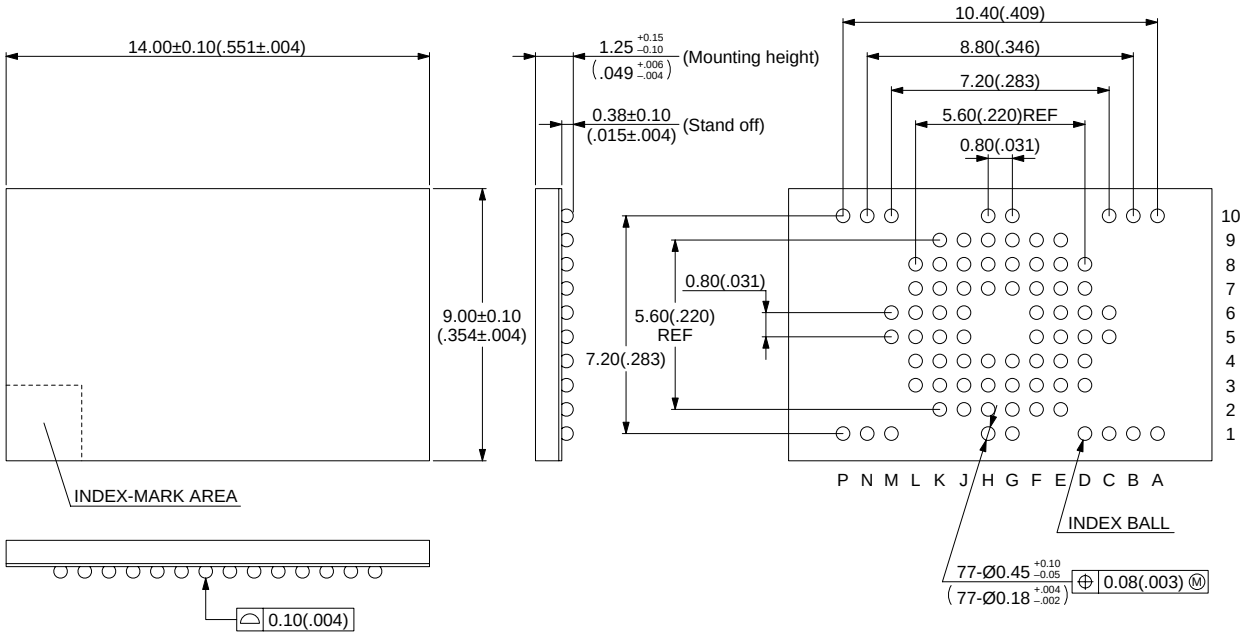
FINE PITCH BALL GRID ARRAY PACKAGE
77 PIN PLASTIC

BGA-77P-M01

77-pin plastic FBGA		
	Ball pitch	0.80 mm (Pin pitch)
	Package width × package length	9.0 × 14.0 mm
	Sealing method	Plastic mold
	Mounting height	1.40 mm MAX
	Weight	About 0.26 g
(BGA-77P-M01)		

77-pin plastic FBGA
(BGA-77P-M01)



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Dimensions in mm (inches).

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